



### 40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max Tc = +25°C
40V	8.8mΩ @ V <sub>GS</sub> = 10V	64.8A
	$13m\Omega$ @ V <sub>GS</sub> = 5V	53.3A

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- **BLDC** motors
- DC-DC converters
- Load switches

### **Features**

- Rated to +175°C Ideal for High Ambient Temperature
- 100% Unclamped Inductive Switching, Test in Production -Ensures More Reliable And Robust End Application
- Low RDS(ON) Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

An automotive-compliant part is available under separate datasheet (DMTH4008LPSQ)

### **Mechanical Data**

- Package: PowerDI®5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)

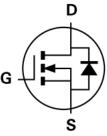




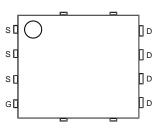
Top View



**Bottom View** 



Internal Schematic



Top View Pin Configuration

Site 2:

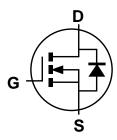
#### PowerDI5060-8/SWP (Type UX)



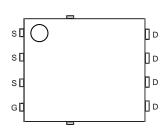




**Bottom View** 



Internal Schematic



Top View Pin Configuration

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



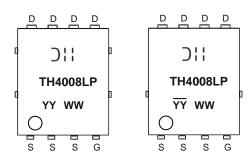
# Ordering Information (Note 4)

Part Number	Pookogo	Packing		
Fait Number	Package	Qty.	Carrier	
DMTH4008LPS-13	PowerDI5060-8	2,500	Tape & Reel	
DMTH4008LPS-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note:

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



☐ I = Manufacturer's Marking
TH4008LP = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 23 = 2023)
WW = Week Code (01 to 53)

# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		$V_{DSS}$	40	V
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current, VGS = 10V (Note 5)	$T_A = +25^{\circ}C$ $T_A = +100^{\circ}C$	lo	14.4 10.2	А
Continuous Drain Current, VGS = 10V (Note 6)	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	lo	64.8 45.8	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	110	А	
Maximum Continuous Body Diode Forward Current (Note 6)	ls	55.5	A	
Avalanche Current, L = 0.1mH		las	22.7	А
Avalanche Energy, L = 0.1mH		Eas	25.7	mJ

### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	2.99	W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	50.4	°C/W
Total Power Dissipation (Note 6)	T <sub>C</sub> = +25°C	P <sub>D</sub>	55.5	W
Thermal Resistance, Junction to Case (Note 6)		R <sub>e</sub> JC	2.7	°C/W
Operating and Storage Temperature Range		T.i Tstg	-55 to +175	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).



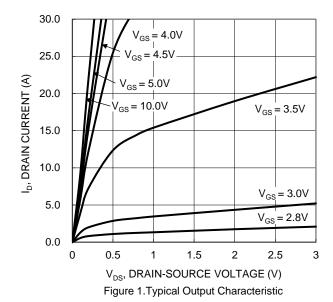
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	$V_{DS} = 32V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	1.6	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	D	_	7.3	8.8	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 10A
Static Dialif-Source Off-Resistance	R <sub>DS(ON)</sub>	_	10	13	11122	$V_{GS} = 5V, I_D = 10A$
Diode Forward Voltage	V <sub>SD</sub>	_	0.8	1.0	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 10A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C <sub>iss</sub>	_	1,088	_		V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1MHz
Output Capacitance	Coss	_	322	_	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	27	_		
Gate Resistance	Rg	_	2.6	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	7.4	_		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	15.3	_	nC	V <sub>DS</sub> = 20V, I <sub>D</sub> = 10A
Gate-Source Charge	Qgs	_	2.4	_	IIC	
Gate-Drain Charge	Qgd	_	3.4	_		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.3	_		
Turn-On Rise Time	t <sub>R</sub>	_	7.5	_	l	$V_{DD} = 20V, V_{GS} = 10V,$ $I_{D} = 10A, R_{G} = 6\Omega$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	16.7	_	ns	
Turn-Off Fall Time	tF	_	5.8	_		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	20.2	_	ns	I_ 40A di/d+ 400A/u-
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	8.9	_	nC   I <sub>F</sub> = 10A, di/dt = 100A/µs	

Notes:

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





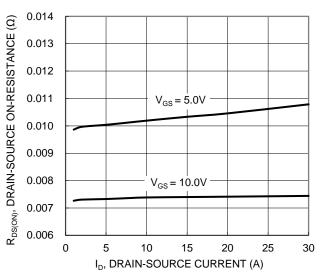


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

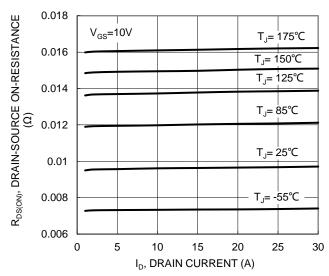


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

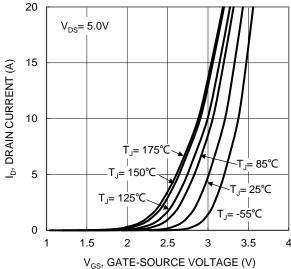


Figure 2. Typical Transfer Characteristic

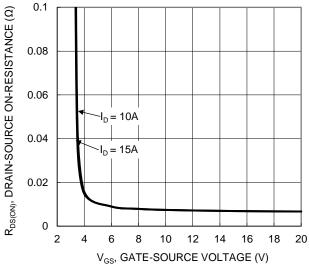


Figure 4. Typical Transfer Characteristic

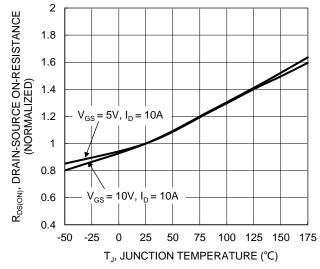


Figure 6. On-Resistance Variation with Temperature





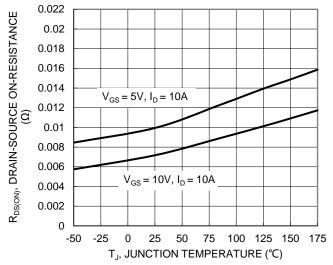
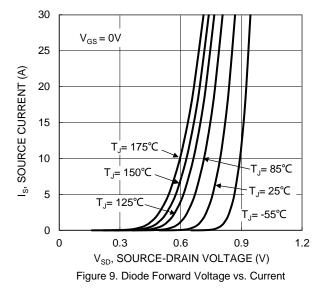


Figure 7. On-Resistance Variation with Temperature



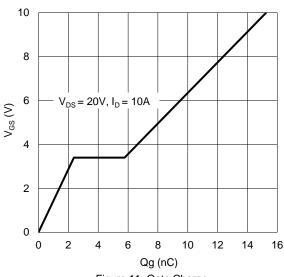


Figure 11. Gate Charge

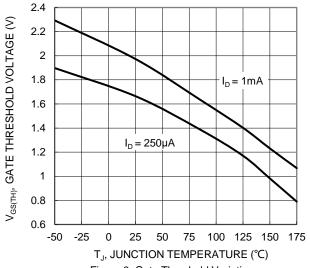
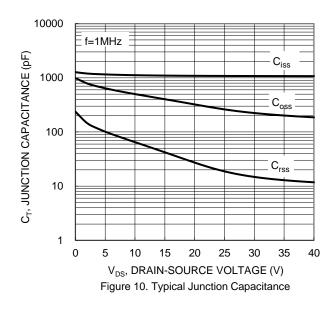


Figure 8. Gate Threshold Variation vs. JunctionTemperature



1000 R<sub>DS(ON)</sub> LIMITED 100 ID, DRAIN CURRENT (A) P<sub>w</sub>=10µs 10 1 T<sub>J(MAX)</sub>=175°C =100ms T<sub>C</sub>=25°C Single Pulse DUT on infinite heatsink V<sub>GS</sub>=10V 0.01 0.1 1 10 100 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



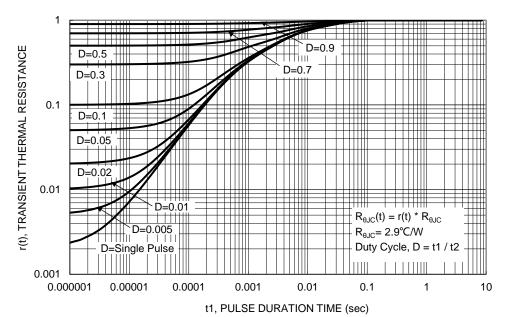


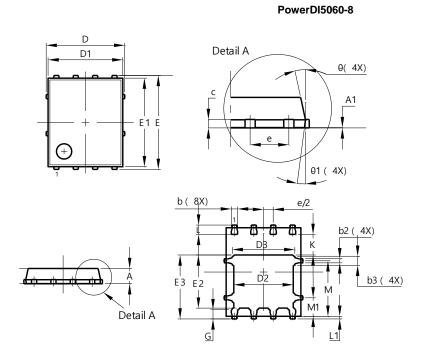
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

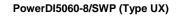
Please see http://www.diodes.com/package-outlines.html for the latest version.

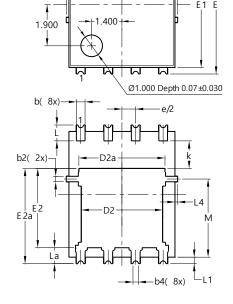
#### Site 1:



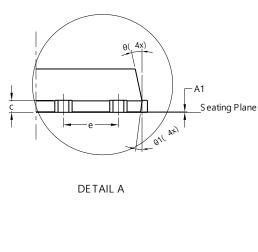
PowerDI5060-8				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0.00	0.05	-	
b	0.33	0.51	0.41	
b2	0.200	0.350	0.273	
b3	0.40	0.80	0.60	
С	0.230	0.330	0.277	
D		5.15 BSC		
D1	4.70	5.10	4.90	
D2	3.70	4.10	3.90	
D3	3.90	4.30	4.10	
Е	(	6.15 BSC		
E1	5.60	6.00	5.80	
E2	3.28	3.68	3.48	
E3	3.99	4.39	4.19	
е	•	1.27 BSC	,	
G	0.51	0.71	0.61	
K	0.51	-	-	
L	0.51	0.71	0.61	
L1	0.100	0.200	0.175	
M	3.235	4.035	3.635	
M1	1.00	1.40	1.21	
Θ	10°	12°	11°	
Θ1	6°	8°	7°	
All Dimensions in mm				

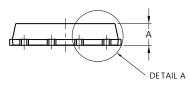
Site 2:





-D1





PowerDI5060-8/SWP (Type UX)			
Dim	Min	Max	Тур
Α	0.90	1.10	1.00
A1	0	0.05	
b	0.30	0.50	0.41
b2	0.20	0.35	0.25
b4		).25REF	•
С	0.230	0.330	0.277
D	5	.15 BS0	)
D1	4.70	5.10	4.90
D2	3.56	3.96	3.76
D2a	3.78	4.18	3.98
Е	6	.40 BS0	)
E1	5.60	6.00	5.80
E2	3.46	3.86	3.66
E2a	4.195	4.595	4.395
е	1	.27BSC	)
k	1.05		
L	0.635	0.835	0.735
La	0.635	0.835	0.735
L1	0.200	0.400	0.300
L1a	0.050REF		
L4	0.025	0.225	0.125
M	3.205	4.005	3.605
θ	10°	12°	11°
θ1	6°	8°	7°
All Dimensions in mm			

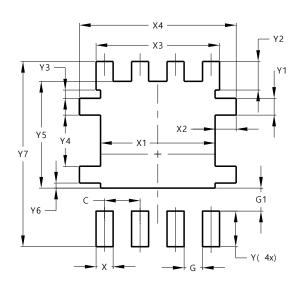


# **Suggested Pad Layout**

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

### Site 1:

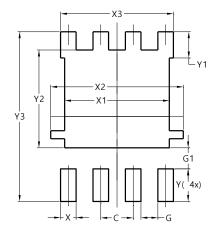
### PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

### PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)	
С	1.270	
G	0.660	
G1	0.820	
X	0.610	
X1	4.100	
X2	5.190	
Х3	4.420	
Y	1.270	
Y1	1.020	
Y2	3.810	
Y3	6.610	



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